



MOTOROLA

MC14511B

BCD-TO-SEVEN SEGMENT LATCH/DECODER/DRIVER

The MC14511B BCD-to-seven segment latch/decoder/driver is constructed with complementary MOS (CMOS) enhancement mode devices and NPN bipolar output drivers in a single monolithic structure. The circuit provides the functions of a 4-bit storage latch, an 8421 BCD-to-seven segment decoder, and an output drive capability. Lamp test (LT), blanking (BI), and latch enable (LE) inputs are used to test the display, to turn-off or pulse modulate the brightness of the display, and to store a BCD code, respectively. It can be used with seven-segment light emitting diodes (LED), incandescent, fluorescent, gas discharge, or liquid crystal readouts either directly or indirectly.

Applications include instrument (e.g., counter, DVM, etc.) display driver, computer/calculator display driver, cockpit display driver, and various clock, watch, and timer uses.

- Low Logic Circuit Power Dissipation
- High Current Sourcing Outputs (Up to 25 mA)
- Latch Storage of Code
- Blanking Input
- Lamp Test Provision
- Readout Blanking on all Illegal Input Combinations
- Lamp Intensity Modulation Capability
- Time Share (Multiplexing) Facility
- Supply Voltage Range = 3.0 V to 18 V
- Capable of Driving Two Low-power TTL Loads, One Low-power Schottky TTL Load or Two HTL Loads Over the Rated Temperature Range
- Chip Complexity: 216 FETs or 54 Equivalent Gates

MAXIMUM RATINGS (Voltages referenced to V_{SS}):

Rating	Symbol	Value	Unit
DC Supply Voltage	V _{DD}	-0.5 to +18	V
Input Voltage, All Inputs	V _{in}	-0.5 to V _{DD} + 0.5	V
DC Current Drain per Input Pin	I _i	10	mA
Operating Temperature Range - AL Device CL/CP Device	T _A	-55 to +125 -40 to -85	°C
Storage Temperature Range	T _{stg}	-65 to -150	°C
Maximum Output Drive Current (Source per Output)	I _{OHmax}	25	mA
Maximum Continuous Output Power (Source per Output) †	P _{OHmax}	50	mW

† P_{OHmax} = I_{OH} (V_{DD} - V_{OH})

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. A destructive high current mode may occur if V_{in} and V_{out} are not constrained to the range V_{SS} ≤ (V_{in} or V_{out}) ≤ V_{DD}.

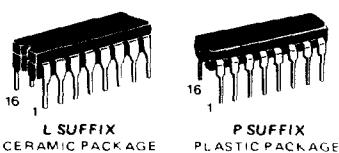
Due to the sourcing capability of this circuit, damage can occur to the device if V_{DD} is applied, and the outputs are shorted to V_{SS} and are at a logical 1 (See Maximum Ratings).

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}).

CMOS MSI

(LOW-POWER COMPLEMENTARY MOS)

BCD-TO-SEVEN SEGMENT LATCH/DECODER/DRIVER

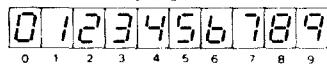
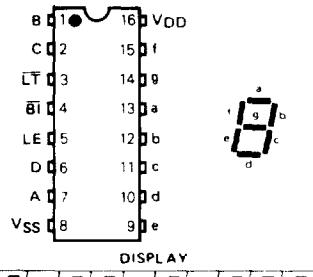


ORDERING INFORMATION

A Series -55°C to +125°C
MC14XXXBAL (Ceramic Package Only)

C Series -40°C to +85°C
MC14XXXBCP (Plastic Package)
MC14XXXBCL (Ceramic Package)

PIN ASSIGNMENT



TRUTH TABLE

INPUTS								OUTPUTS							
LE	BI	LT	D	C	B	A	a	b	c	d	e	f	g	DISPLAY	
x	x	0	x	x	x	x	1	1	1	1	1	1	1	8	
x	0	1	x	x	x	x	0	0	0	0	0	0	0	Blank	
0	1	1	0	0	0	0	1	1	1	1	1	1	1	0	
0	1	1	0	0	0	0	1	0	1	0	1	0	1	2	
0	1	1	0	0	0	0	1	1	1	1	1	0	1	1	
0	1	1	0	0	0	0	1	1	1	1	1	0	1	1	
0	1	1	0	0	0	0	1	0	1	1	1	1	1	4	
0	1	1	0	0	0	0	1	1	0	1	1	1	1	5	
0	1	1	0	0	0	0	1	1	1	1	1	1	1	6	
0	1	1	0	0	0	0	1	1	1	1	0	0	0	7	
0	1	1	0	0	0	0	0	1	1	1	1	1	1	8	
0	1	1	0	0	0	0	0	1	1	1	1	1	1	Blank	
0	1	1	0	0	0	0	0	0	1	1	1	1	1	Blank	
0	1	1	0	0	0	0	0	0	0	1	1	1	1	Blank	
0	1	1	0	0	0	0	0	0	0	0	1	1	1	Blank	
1	1	1	1	1	1	1	0	0	0	0	0	0	0	Blank	

X = Don't Care

* Depends upon the BCD code previously applied when LE = 0

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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic	Symbol	V_{DD} V_{dc}	T_{low}^*		25°C			T_{high}^*		Unit
			Min	Max	Min	Typ	Max	Min	Max	
Output Voltage $V_{in} = V_{DD}$ or 0	V_{OL}	5.0	..	0.05	-	0	0.05	-	0.05	V
		10	-	0.05	-	0	0.05	-	0.05	
		15	-	0.05	-	0	0.05	-	0.05	
	V_{OH}	5.0	4.1	-	4.1	4.57	-	4.1	-	V
		10	9.1	-	9.1	9.58	-	9.1	-	
		15	14.1	-	14.1	14.59	-	14.1	-	
Input Voltage [#] $(V_O = 3.8 \text{ or } 0.5 \text{ V})$ $(V_O = 8.8 \text{ or } 1.0 \text{ V})$ $(V_O = 13.8 \text{ or } 1.5 \text{ V})$	V_{IL}	5.0	-	1.5	-	2.25	1.5	-	1.5	V
		10	-	3.0	-	4.50	3.0	-	3.0	
		15	-	4.0	-	6.75	4.0	-	4.0	
	V_{IH}	5.0	3.5	-	3.5	2.75	-	3.5	-	V
		10	7.0	-	7.0	5.50	-	7.0	-	
		15	11.0	-	11.0	8.25	-	11.0	-	
Output Drive Voltage (AL Device)	Source	V_{OH}	5.0	4.10	-	4.10	4.57	-	4.1	V
			-	-	-	4.24	-	-	-	
			10	3.90	-	3.90	4.12	-	3.5	
			-	-	-	3.94	-	-	-	
			15	3.40	-	3.40	3.70	-	3.0	
			-	-	-	3.54	-	-	-	
		10	9.10	-	9.10	9.53	-	9.1	-	V
			-	-	-	9.26	-	-	-	
			9.00	-	9.00	9.17	-	8.6	-	
			-	-	-	9.04	-	-	-	
			8.60	-	8.60	8.90	-	8.2	-	
			-	-	-	8.70	-	-	-	
		15	14.1	-	14.1	14.59	-	14.1	-	V
			-	-	-	14.27	-	-	-	
			14.0	-	14.0	14.13	-	13.6	-	
			-	-	-	14.07	-	-	-	
			13.6	-	13.6	13.95	-	13.2	-	
			-	-	-	13.70	-	-	-	
Output Drive Voltage (CL/CP Device)	Source	V_{OH}	5.0	4.10	-	4.10	4.57	-	4.1	V
			-	-	-	4.24	-	-	-	
			10	3.60	-	3.60	4.12	-	3.3	
			-	-	-	3.94	-	-	-	
			15	2.80	-	2.80	3.75	-	2.5	
			-	-	-	3.54	-	-	-	
		10	9.10	-	9.10	9.58	-	9.1	-	V
			-	-	-	9.26	-	-	-	
			8.75	-	8.75	9.17	-	8.45	-	
			-	-	-	9.04	-	-	-	
			8.10	-	8.10	8.90	-	7.8	-	
			-	-	-	8.75	-	-	-	
		15	14.1	-	14.1	14.59	-	14.1	-	V
			-	-	-	14.27	-	-	-	
			13.75	-	13.75	14.18	-	13.45	-	
			-	-	-	14.07	-	-	-	
			13.1	-	13.1	13.95	-	12.8	-	
			-	-	-	13.80	-	-	-	
Output Drive Current (AL Device)	Sink	I_{OL}	5.0	0.64	-	0.51	0.88	-	0.36	mA
			10	1.6	-	1.3	2.25	-	0.9	
			15	4.2	-	3.4	8.8	-	2.4	
			-	-	-	-	-	-	-	
Output Drive Current (CL/CP Device)	Sink	I_{OL}	5.0	0.52	-	0.44	0.88	-	0.36	mA
			10	1.3	-	1.1	2.25	-	0.9	
			15	3.6	-	3.0	8.8	-	2.4	

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(Continued)

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ELECTRICAL CHARACTERISTICS (Continued)

Characteristic	Symbol	V_{DD} Vdc	T_{low}^*		25°C			T_{high}^*		Unit	
			Min	Max	Min	Typ	Max	Min	Max		
Input Current (AL Device)	I_{in}	15	—	± 0.1	—	± 0.00001	± 0.1	—	± 1.0	μA	
Input Current (CL/CP Device)	I_{in}	15	—	± 0.3	—	± 0.00001	± 0.3	—	± 1.0	μA	
Input Capacitance	C_{in}	—	—	—	—	5.0	7.5	—	—	pF	
Quiescent Current (AL Device) (Per Package) $V_{in}=0$ or V_{DD} , $I_{out} = 0 \mu A$	I_{DD}	5.0 10 15	— — —	5.0 10 20	— — —	0.005 0.010 0.015	5.0 10 20	— — —	150 300 600	μA	
Quiescent Current (CL/CP Device) (Per Package) $V_{in}=0$ or V_{DD} , $I_{out} = 0 \mu A$	I_{DD}	5.0 10 15	— — —	20 40 80	— — —	0.005 0.010 0.015	20 40 80	— — —	150 300 600	μA	
Total Supply Current **† (Dynamic plus Quiescent, Per Package) ($C_L = 50 pF$ on all outputs, all buffers switching)	I_T	5.0 10 15	— — —	—	—	$I_T = (1.9 \mu A/kHz) f + I_{DD}$ $I_T = (3.8 \mu A/kHz) f + I_{DD}$ $I_T = (5.7 \mu A/kHz) f + I_{DD}$	— — —	— — —	— — —	— — —	μA

* $T_{low} = -55^\circ C$ for AL Device, $-40^\circ C$ for CL/CP Device.

** $T_{high} = +125^\circ C$ for AL Device, $+85^\circ C$ for CL/CP Device.

Noise immunity specified for worst-case input combination.

Noise Margin for both "1" and "0" level =

$$1.0 \text{ Vdc min @ } V_{DD} = 5.0 \text{ Vdc}$$

$$2.0 \text{ Vdc min @ } V_{DD} = 10 \text{ Vdc}$$

$$2.5 \text{ Vdc min @ } V_{DD} = 15 \text{ Vdc}$$

† To calculate total supply current at loads other than $50 pF$.

$$I_T(C_L) = I_T(50 pF) + 3.5 \times 10^{-3} (C_L - 50) V_{DD} f$$

where: I_T is in μA (per package), C_L in pF , V_{DD} in Vdc ,
and f in kHz is input frequency.

** The formulas given are for the typical characteristics only at $25^\circ C$.

SWITCHING CHARACTERISTICS* ($C_L = 50 pF$, $T_A = 25^\circ C$)

Characteristic	Symbol	V_{DD} Vdc	Min	Typ	Max	Unit
Output Rise Time $t_{TLH} = (0.40 \text{ ns/pF}) C_L + 20 \text{ ns}$ $t_{TLH} = (0.25 \text{ ns/pF}) C_L + 17.5 \text{ ns}$ $t_{TLH} = (0.20 \text{ ns/pF}) C_L + 15 \text{ ns}$	t_{TLH}	5.0 10 15	— — —	40 30 25	80 60 50	ns
Output Fall Time $t_{THL} = (1.5 \text{ ns/pF}) C_L + 50 \text{ ns}$ $t_{THL} = (0.75 \text{ ns/pF}) C_L + 37.5 \text{ ns}$ $t_{THL} = (0.55 \text{ ns/pF}) C_L + 37.5 \text{ ns}$	t_{THL}	5.0 10 15	— — —	125 75 65	250 150 130	ns
Data Propagation Delay Time $t_{PLH} = (0.40 \text{ ns/pF}) C_L + 620 \text{ ns}$ $t_{PLH} = (0.25 \text{ ns/pF}) C_L + 237.5 \text{ ns}$ $t_{PLH} = (0.20 \text{ ns/pF}) C_L + 165 \text{ ns}$ $t_{PHL} = (1.3 \text{ ns/pF}) C_L + 655 \text{ ns}$ $t_{PHL} = (0.60 \text{ ns/pF}) C_L + 260 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 182.5 \text{ ns}$	t_{PLH} t_{PHL}	5.0 10 15 5.0 10 15	— — — — — —	640 250 175 720 290 200	1280 500 350 1440 580 400	ns
Blank Propagation Delay Time $t_{PLH} = (0.30 \text{ ns/pF}) C_L + 585 \text{ ns}$ $t_{PLH} = (0.26 \text{ ns/pF}) C_L + 187.5 \text{ ns}$ $t_{PLH} = (0.15 \text{ ns/pF}) C_L + 142.5 \text{ ns}$ $t_{PHL} = (0.85 \text{ ns/pF}) C_L + 442.5 \text{ ns}$ $t_{PHL} = (0.45 \text{ ns/pF}) C_L + 177.5 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 142.5 \text{ ns}$	t_{PLH} t_{PHL}	5.0 10 15 5.0 10 15	— — — — — —	600 200 150 485 200 160	750 300 220 970 400 320	ns
Lamp Test Propagation Delay Time $t_{PLH} = (0.45 \text{ ns/pF}) C_L + 290.5 \text{ ns}$ $t_{PLH} = (0.25 \text{ ns/pF}) C_L + 112.5 \text{ ns}$ $t_{PLH} = (0.20 \text{ ns/pF}) C_L + 80 \text{ ns}$ $t_{PHL} = (1.3 \text{ ns/pF}) C_L + 248 \text{ ns}$ $t_{PHL} = (0.45 \text{ ns/pF}) C_L + 102.5 \text{ ns}$ $t_{PHL} = (0.35 \text{ ns/pF}) C_L + 72.5 \text{ ns}$	t_{PLH} t_{PHL}	5.0 10 15 5.0 10 15	— — — — — —	313 125 90 313 125 90	625 250 180 625 250 180	ns
Setup Time	t_{SU}	5.0 10 15	100 40 30	— — —	— — —	ns
Hold Time	t_h	5.0 10 15	60 40 30	— — —	— — —	ns
Latch Enable Pulse Width	t_{WL}	5.0 10 15	520 220 130	260 110 65	— — —	ns

* The formulas given are for the typical characteristics only.

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FIGURE 1 – DYNAMIC POWER DISSIPATION
SIGNAL WAVEFORMS

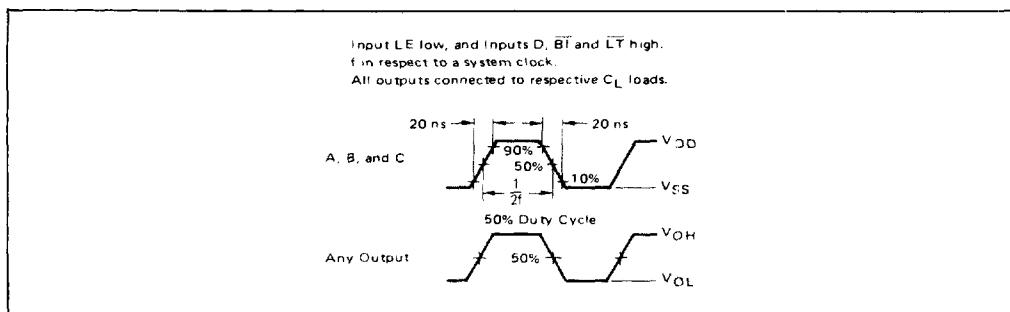
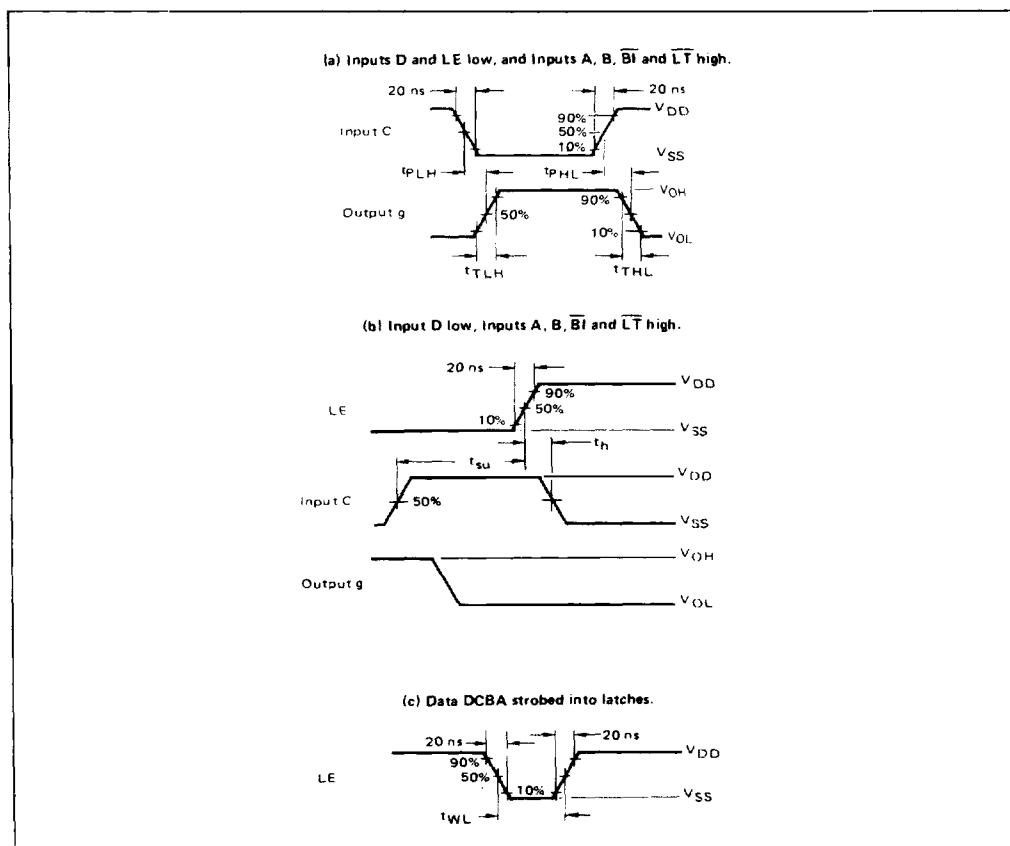
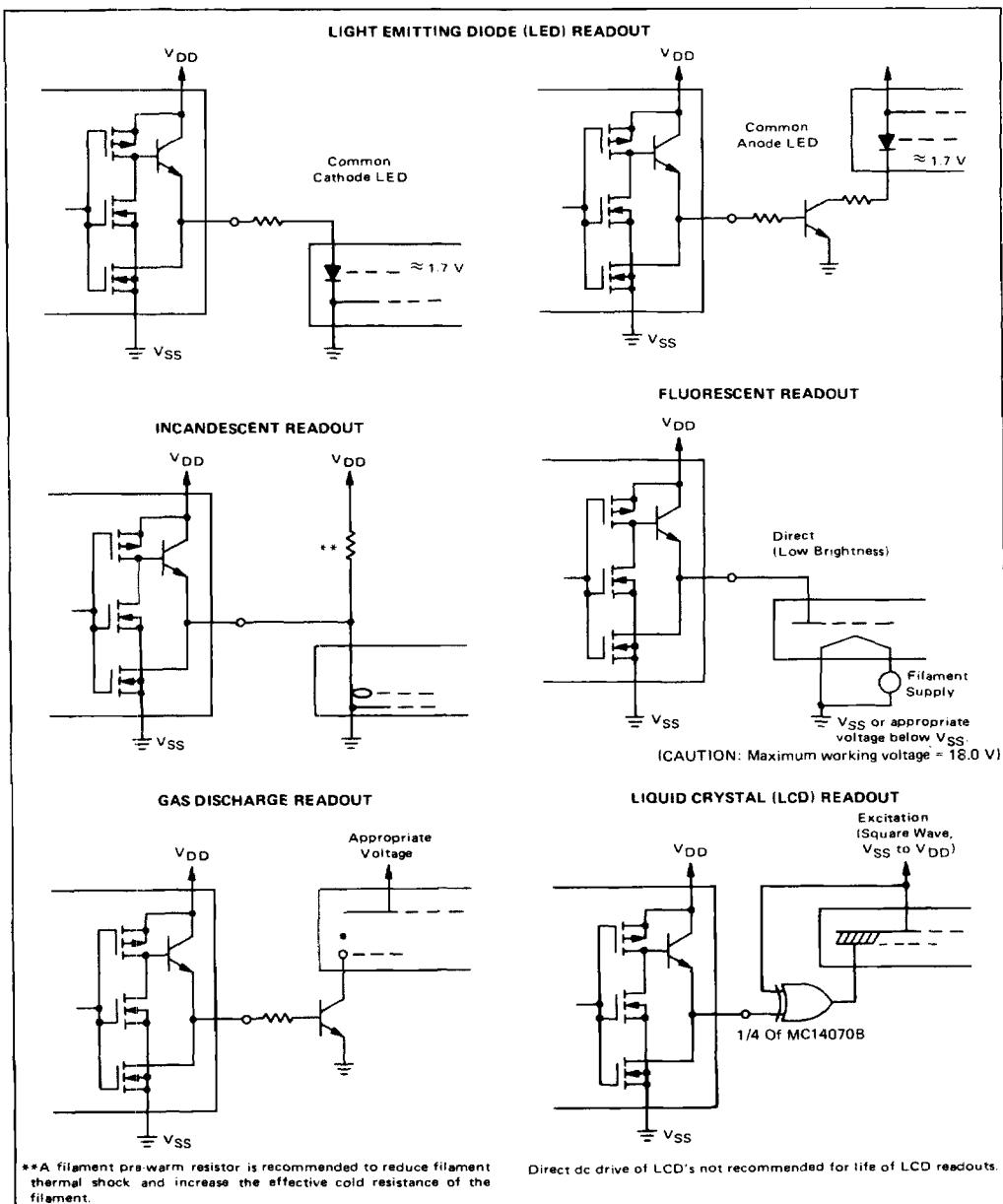


FIGURE 2 – DYNAMIC SIGNAL WAVEFORMS



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CONNECTIONS TO VARIOUS DISPLAY READOUTS



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LOGIC DIAGRAM

